

**Automotive Connectors**  
**【For board-to-FPC】**

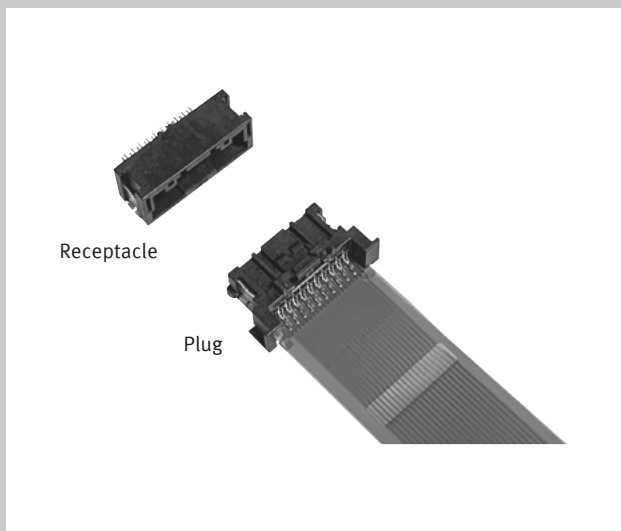
**CF2**

**Product Catalog**

**IN Your  
Future**

# CF2

For Automotive Application with 125°C heat resistance, Connectors for board-to-FPC



## FEATURES

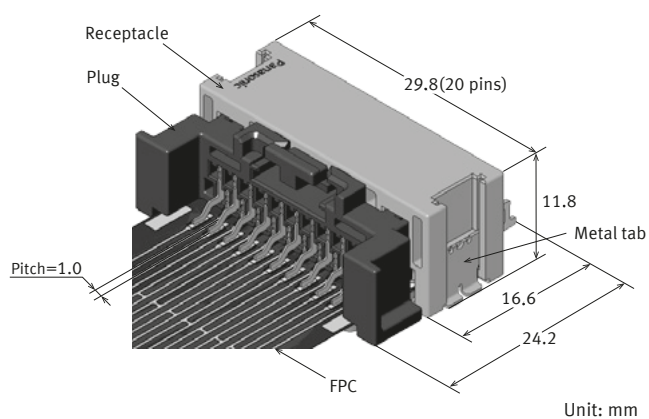
- Available for multiple pins.
- Suitable for automotive applications that require vibration and heat resistance (125°C) characteristics.
- FPCs and boards can be directly connected without relay wiring harnesses.
- Contact reliability is preserved by double-sided contact structure.

## APPLICATIONS

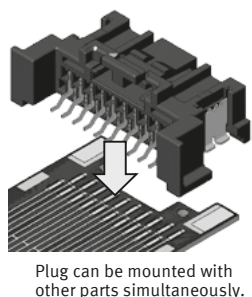
- Connection of board and FPC in DRL/rear lamp.
- Connection of board and FPC in BMS.

## DETAILED FEATURES

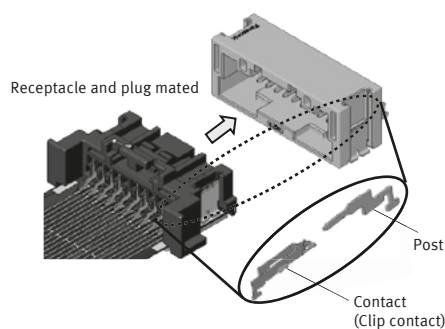
### ■ Mating condition



### ■ Plug SMD mounting

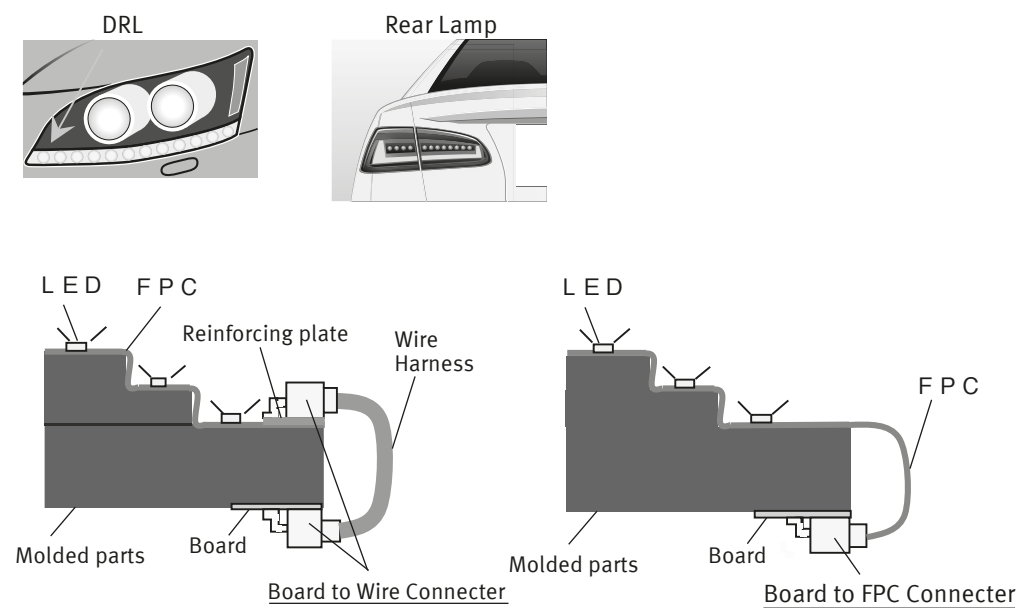


### ■ Metal terminal contact

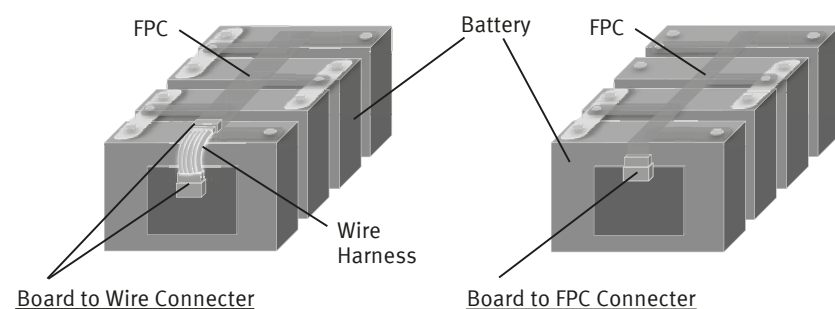


## Principal use

### ■ Connection of board and FPC in DRL/rear lamp



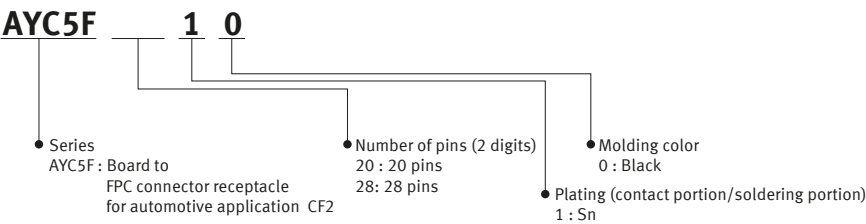
### ■ Connection of board and FPC in BMS (Battery Management System)



<< Elimination of relay wiring harness connectors by using CF2 >>

Receptacle

ORDERING INFORMATION



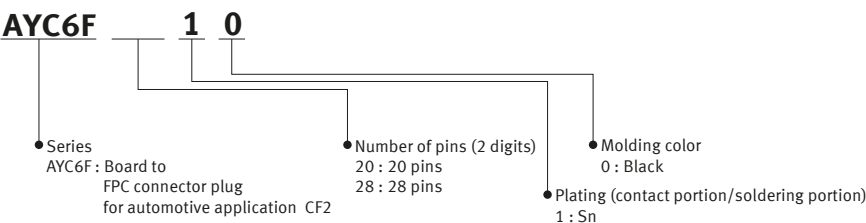
PRODUCT TYPES

Number of pins	Part No.	Packing	
		Inner carton (1-reel)	Outer carton
20 pins	AYC5F2010	250 pieces	500 pieces
28 pins	AYC5F2810		

Note: Order unit: For volume production: 1-inner carton (1-reel) units. For samples, please contact our sales representative.

Plug

ORDERING INFORMATION



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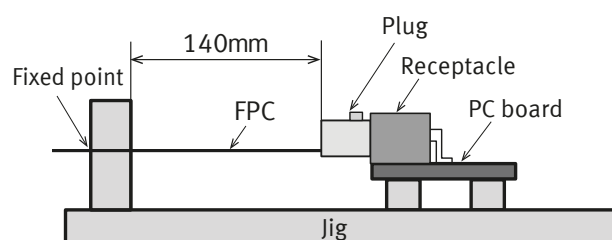
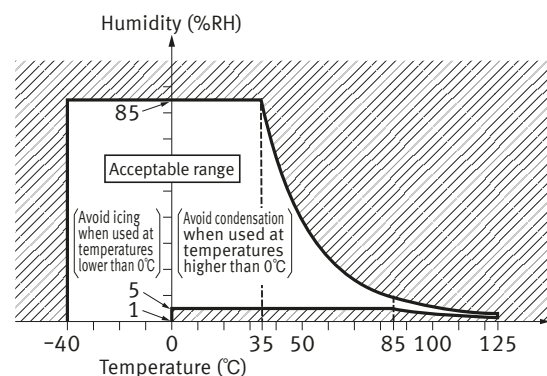
## SPECIFICATIONS

### Characteristics

Item	Specifications	Conditions
Electrical characteristics	Rated current	1.0 A/pin contact
	Rated voltage	50 V DC
	Dielectric strength	800 V AC for 1 min
	Insulation resistance	Min. 100 MΩ
	Contact resistance	Max. 20 mΩ (Initial) Max. 40 mΩ (after test)
Mechanical characteristics	Insertion force	Max. 54.0N (Initial stage : 20 pins) Max. 68.0N (Initial stage : 28 pins)
	Removal force	Max. 36.0N (Initial stage : 20 pins) Max. 50.0N (Initial stage : 28 pins)
	Housing lock force	Min. 120.0 N (Initial)
Environmental characteristics	Temperature and humidity of ambient storage and transportation	-40 to +125 °C (Including temperature rise when applying current) (Storage and transportation temperature is -40 to +50 °C in a packing state.) *1
	Soldering heat resistance	The initial specification must be satisfied electrically and mechanically
	Thermal shock resistance (Receptacle and plug mated)	After 500 cycles Contact resistance: Max. 40 mΩ
	Humidity resistance (Receptacle and plug mated)	After 96 hours Contact resistance: Max. 40 mΩ Insulation resistance: Min. 100 MΩ
	Heat resistance (Receptacle and plug mated)	After 120 hours Contact resistance: Max. 40 mΩ
	Vibration resistance (Receptacle and plug mated)	Current shut off should not exceed 1μs during vibration test. (Contact resistance: Max. 40 mΩ)
	Shock resistance (Receptacle and plug mated)	Current shut off should not exceed 1μs during shock test.
Lifetime characteristics	Insertion and removal life	10 times (Contact resistance: Max. 40 mΩ)
Solder paste thickness		The initial specification must be satisfied electrically and mechanically
		Recommendation t=0.15 mm

\*1. As the humidity range differs depending on the ambient temperature, the humidity range indicated below should be used.  
This temperature and humidity range does not guarantee permanent performance.

\*2. Fig.1



## ■ Material and surface treatment

### ● Receptacle

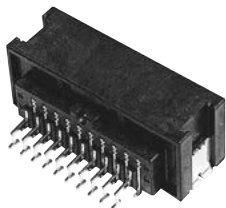
Part name	Material	Color	Surface treatment
Body	LCP resin (UL94V-0)	Black	—
Post	Copper alloy	—	Contact portion: Sn plating over nickel Soldering portion: Sn plating over nickel
Metal tab	Copper alloy	—	Soldering portion: Sn plating over nickel

### ● Plug

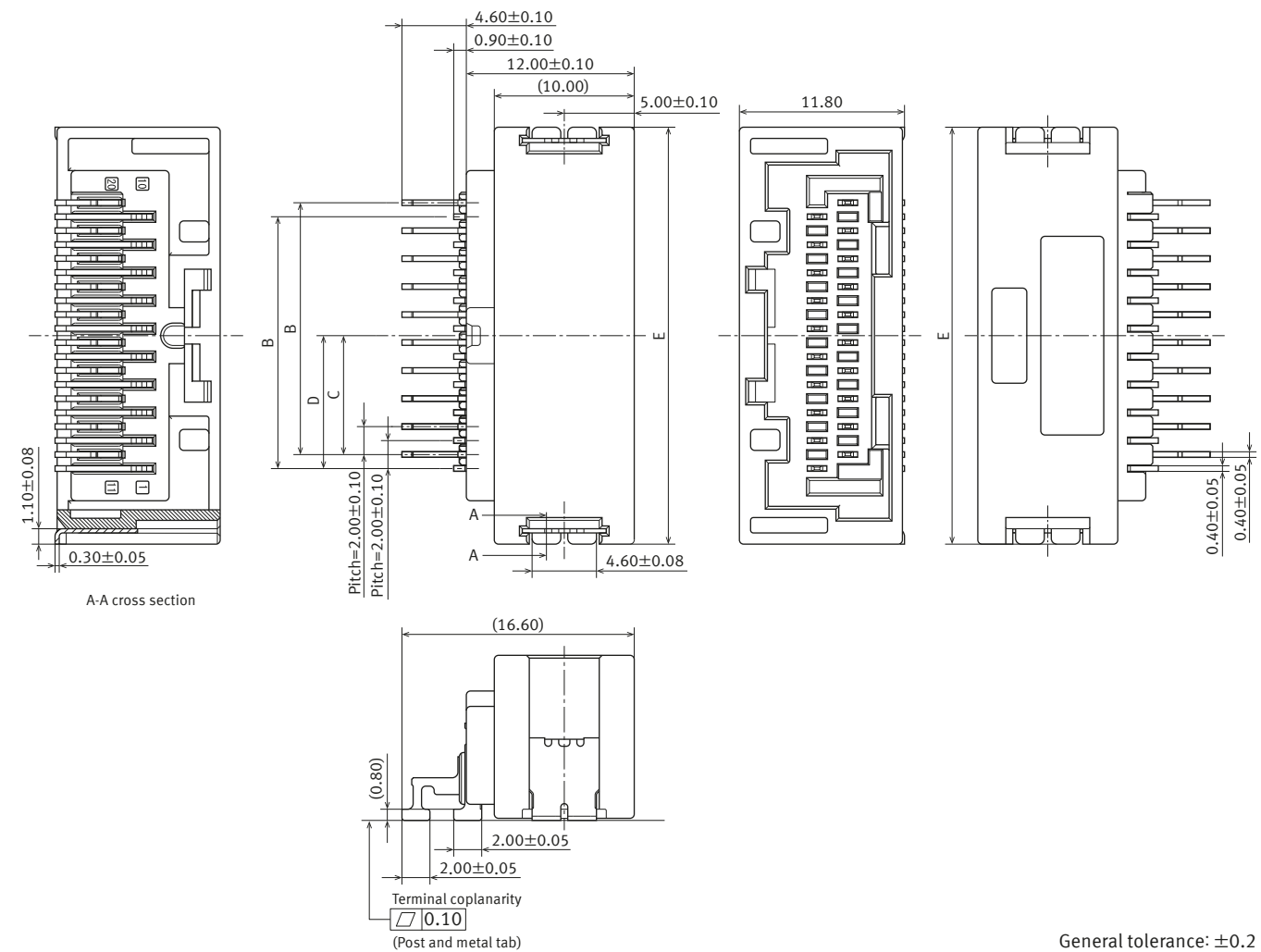
Part name	Material	Color	Surface treatment
Housing	LCP resin (UL94V-0)	Black	—
Contact	Copper alloy	—	Contact portion: Sn plating over nickel Soldering portion: Sn plating over nickel
Metal tab	Copper alloy	—	Soldering portion: Sn plating over nickel

■ Receptacle  
● 20 pins, 28 pins

**CAD**



External dimensions



General tolerance: ±0.2

Dimension table

Dimensions Number of pins	B	C	D	E
20	18.00	8.50	9.50	29.80
28	26.00	12.50	13.50	37.80

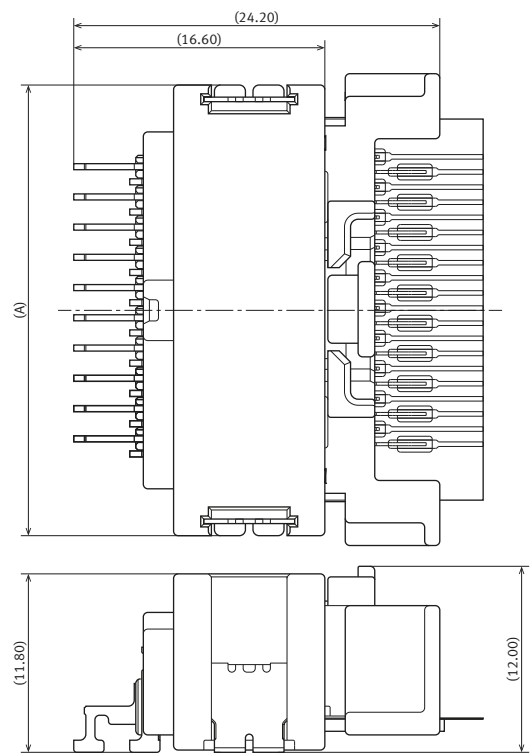




Mating condition

CAD

External dimensions



Dimension table

Dimensions	A
Number of pins	
20	29.80
28	37.80

PACKAGING SPECIFICATIONS

Unit: mm

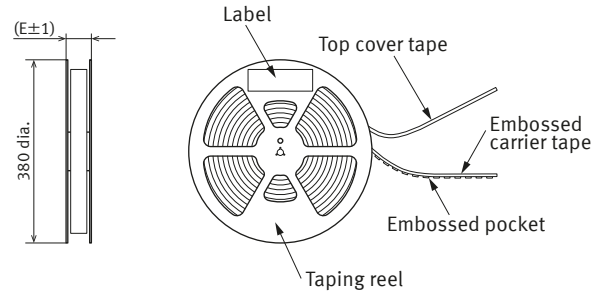
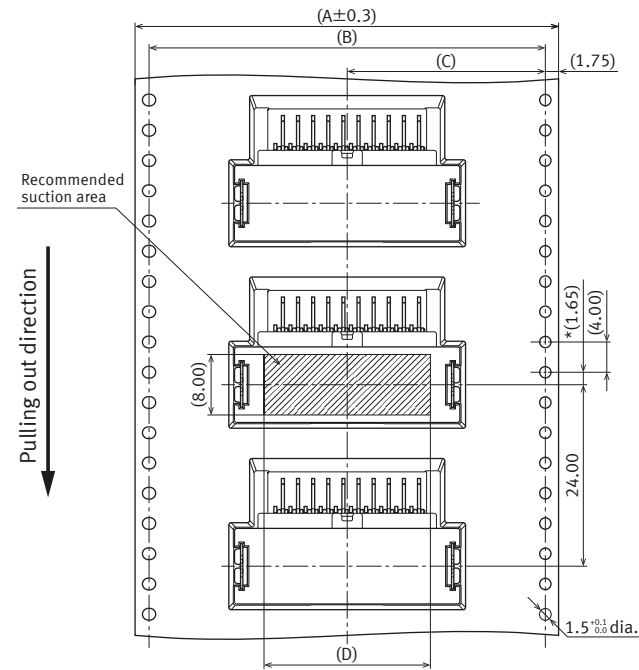
■ Receptacle

● Specifications for taping

In accordance with JIS C 0806-3: 1999.  
However, does not apply to distance between center of round feed hole and center of embossed part.  
\*Part dimension: Distance between center of round feed hole and center of recommended suction area.

● Specifications for the plastic reel

In accordance with EIAJ ET-7200B.



● Dimension table

Number of pins	A	B	C	D	E
20	56.0	52.4	26.2	22.00	57.4
28	56.0	52.4	26.2	30.00	57.4

● Receptacle orientation with respect to embossed tape feeding direction

Direction of tape progress	Type	Receptacle

■ Plug

● Specifications for taping

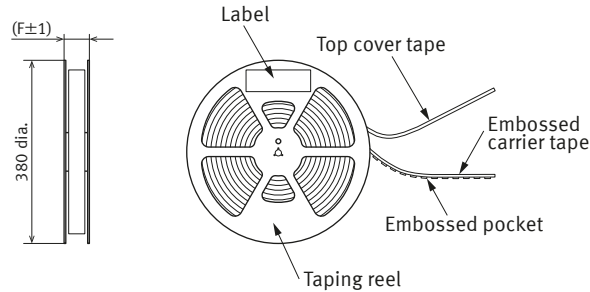
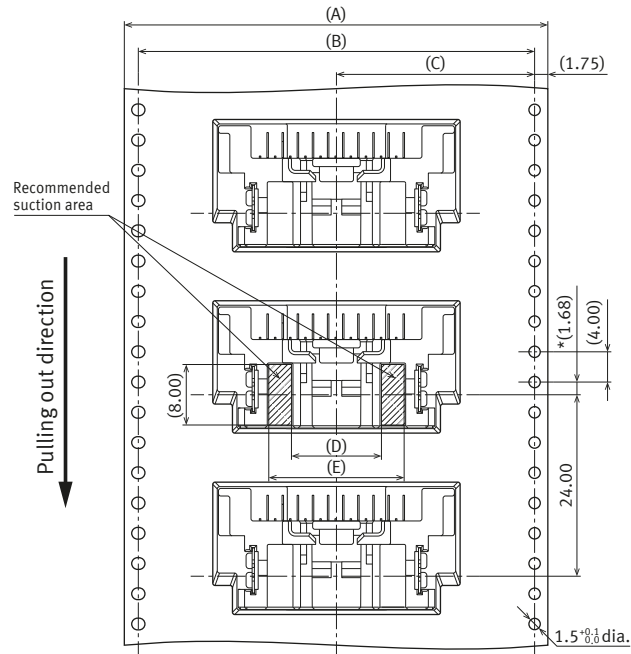
In accordance with JIS C 0806-3:1999.

However, does not apply to distance between center of round feed hole and center of embossed part.

\*Part dimension: Distance between center of round feed hole and center of recommended suction area.

● Specifications for the plastic reel

In accordance with EIAJ ET-7200B.



● Dimension table

Number of pins	A	B	C	D	E	F
20	56.0	52.4	26.2	11.90	17.90	57.4
28	56.0	52.4	26.2	11.90	25.90	57.4

● Plug orientation with respect to embossed tape feeding direction

Type	Plug
Direction of tape progress ↓	

# Notes on Using Connectors for Automotive Application

## PRECAUTION FOR USE

Unit: mm

### ■ Design of PC board and FPC board

Conduct the recommended foot pattern design, in order to preserve the mechanical strength of soldering portion.

### ■ Recommended PC board and FPC board patterns

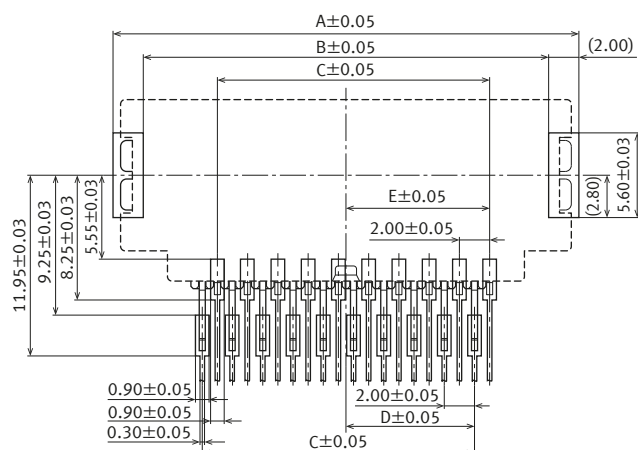
In order to reduce solder and flux rise, solder bridges and other issues make sure the proper levels of solder is used.

The figures are recommended patterns. Please use them as a reference.

### ■ Receptacle

#### ● Recommended PC board pattern

(Mounting layout, TOP VIEW)

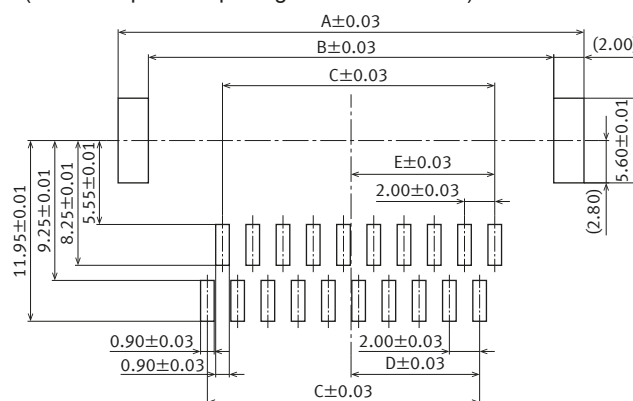


#### ● Recommended metal mask pattern

Metal mask thickness: When 150 μm

(Post portion opening area ratio: 100 %)

(Metal tab portion opening area ratio: 100 %)



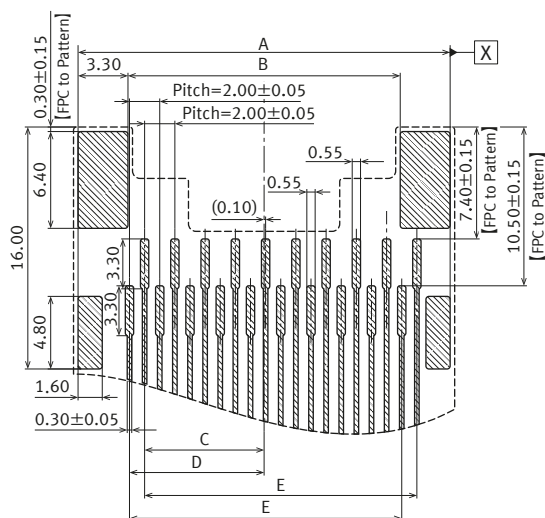
#### ● Dimension table

Dimensions	A	B	C	D	E
Number of pins					
20	30.80	26.80	18.00	8.50	9.50
28	38.80	34.80	26.00	12.50	13.50

## ■ Plug

### ● Recommended FPC board pattern

- Copper foil pattern (and outer shape of FPC)



General tolerance:  $\pm 0.1$

Note 1) : Pad area (Copper foil)

2) : Cover film area

3) Unspecified corner : R 0.20

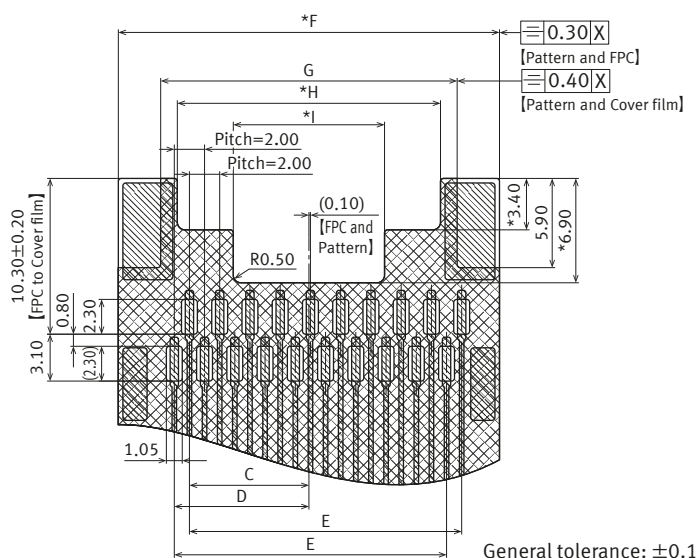
4) Dimensions “\*” are defined in the FPC drawing.

5) Pad area is rust proofing.

Dimension table

Dimensions	A	B	C	D	E
Number of pins					
20	24.60	18.00	7.90	8.90	18.00
28	32.60	26.00	11.90	12.90	26.00

- Diagram of outer shape of FPC and Cover film attachment [(1)]

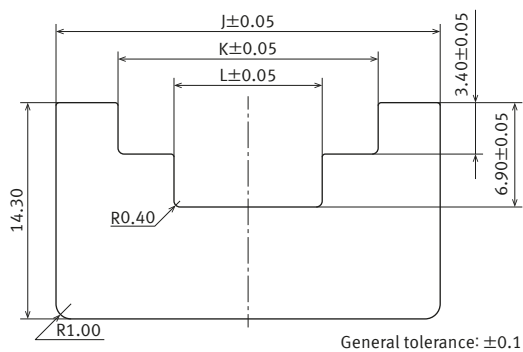


General tolerance:  $\pm 0.1$

### ● Dimension table

Dimensions	C	D	E	F	G	H	I
Number of pins							
20	7.90	8.90	18.00	25.20	19.60	17.40	10.00
28	11.90	12.90	26.00	33.20	27.60	25.40	18.00

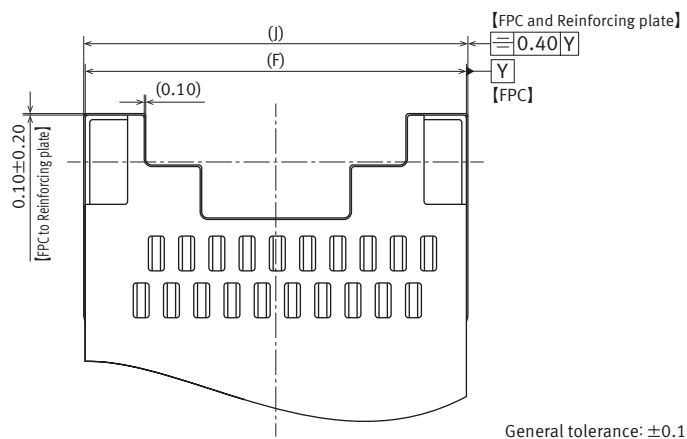
## • Diagram of reinforcing plate [(2)]



## ● Dimension table

Dimensions Number of pins	J	K	L
20	25.40	17.20	9.80
28	33.40	25.20	17.80

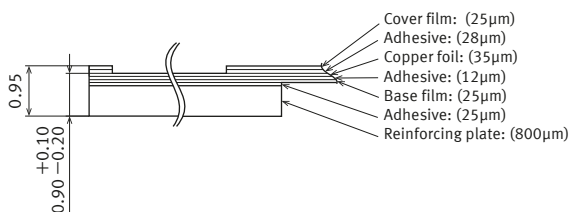
## • Diagram of reinforcing plate attachment [(1)+(2)]



## ● Dimension table

Dimensions Number of pins	F	J
20	25.20	25.40
28	33.20	33.40

## • Layer composition

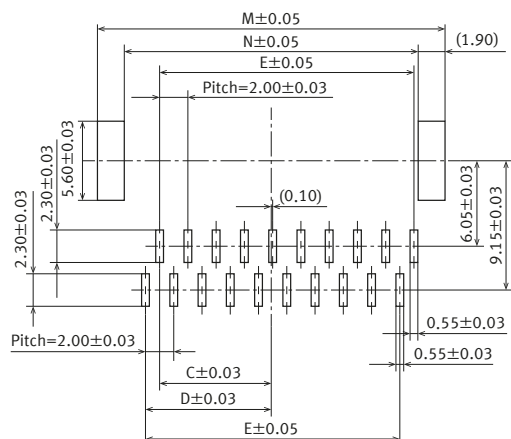


## • Recommended metal mask pattern

Metal mask thickness : When 150 $\mu$ m

(Contact portion opening area ratio : 100%)

(Metal tab portion opening area ratio : 76%)



## ● Dimension table

Dimensions Number of pins	C	D	E	M	N
20	7.90	8.90	18.00	24.60	20.80
28	11.90	12.90	26.00	32.60	28.80

## ABOUT SAFETY REMARKS

Observe the following safety precautions to prevent accidents and injuries.

- Do not use these connectors beyond the specification sheets. The usage outside of specified rated current, dielectric strength, and environmental conditions and so on may cause circuitry damage via abnormal heating, smoke, and fire.
- In order to avoid accidents, your thorough specification review is appreciated. Please contact us if your usage is out of the specifications. Otherwise, Panasonic Industry Co., Ltd. cannot guarantee the quality and reliability.

- Panasonic Industry Co., Ltd. is consistently striving to improve quality and reliability.

However, the fact remains that electrical components and devices generally cause failures at a given statistical probability. Furthermore, their durability varies with use environments or use conditions.

In this respect, please check for actual automobile under actual conditions before use.

Continued usage in a state of degraded condition may cause the deteriorated insulation, thus result in abnormal heat, smoke or firing. Please carry out safety design and periodic maintenance including redundancy design, design for fire spread prevention, and design for malfunction prevention so that no accidents resulting in injury or death, fire accidents, or social damage will be caused as a result of failure of the Products or ending life of the Products.

## Mounting

### 1) Regarding PC board and FPC board design

- Refer to the recommended PC board and FPC board pattern for keeping the strength of soldering.

### 2) Connector placement

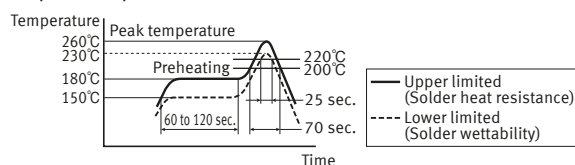
- In case of dry condition, please note the occurrence of static electricity. The product may be adhered to the embossed carrier tape or the cover tape in dry condition. Recommended humidity is from 40 % RH to 60 % RH and please remove static electricity by ionizer in manufacturing process.

### 3) Soldering

#### (1) Reflow soldering

- When cream solder printing is used, screen method is recommended.
- The relation between the screen opening area and foot pattern area should be referred to "Recommended metal mask and PC board pattern" drawings and "Recommended metal mask and FPC board pattern" drawings.
- If it is used with a thickness different from the recommended metal mask thickness, it may not be mounted, or the mounting strength may decrease. Please be careful to metal mask thickness.

- Please be careful to align terminals and solder pads, because this product does not have self-alignment features.
- The following diagram shows the recommended reflow soldering temperature profile.



- Infrared reflow soldering is able to passed two times.
- The temperature is measured at the connector terminals.
- The condition of solder or flux creepage and wettability depend on the type of solder and flux. Please set the reflow temperature and oxygen level by considering the solder and flux characteristics.

#### (2) Manual soldering.

- Please avoid the excessive solder. Because the excessive solder makes creepage at contact portion.
- Please use the soldering iron under specified temperature and times.
- As excessive force to terminal by manual soldering has some possibilities of terminal portion deformation, please be careful to the force by hand.
- Please clean soldering iron tip.

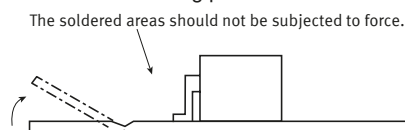
#### (3) Rework of soldering portion.

- Rework shall be only one time.
- Please avoid the supplementary flux in case of rework for soldering bridge, as this may cause flux creepage to contact portion.
- Please use the soldering iron under specified temperature.

4) As the excessive force on the terminals may cause the deformation and the integrity of solderability will be lost during reflow soldering, please avoid dropping or rough handling of the product.

5) When the soldering is not completed, do not mate nor unmate the connectors. And the external compulsory force to the terminal may cause the fixing force lowering between the terminal and the molding or the coplanarity failures.

6) When cutting the PC board after mounting the receptacle, please avoid the stress at the soldering portion.



#### 7) Cleaning treatment

- Cleaning this product is not needed basically. Please note the following points to prevent the negative effect to the product when cleaning is necessary.
- Please keep the cleanliness of the cleaning fluid to make sure that the contact surfaces are not contaminated by the cleaning fluid itself.
- Semi-aqueous cleaning solvent is recommended as some powerful solvent may dissolve the molding portion or the marked letters. Please contact us when other solvent is used.

### Insertion, removal and retention of mating

- This product is designed with ease of handling. However, in order to prevent the deformation or damage of contacts and molding, do not mate the connectors such as the following  
Insertion or removal while prying from right to left or up and down.  
Insertion of upside-down state.
- Inserting the plug with excessive force may break the products.  
Please be careful as excessive force is not applied.
- This product has lock structure for mating. However, the lock may be broken depending on reaction force due to FPC routing. Please confirm sufficiently at usage.
- When remove the connector, please hold the housing while pushing the latch-lock. Pulling the FPC only, will cause the product is damaged.
- Please avoid wiring, such as continue to apply stress to the base of the FPC. It may cause breaking of the FPC or failure of the products.

### Precautions for operating environment and storage environment

- Panasonic Industry Co., Ltd. does not guarantee the failures caused by condensation.
- Please use our products within six months from the date of products acceptance.  
Please confirm solderability, when using after the recommended storage period.

### Other precautions

- When the coating material is used for preventing board isolation deterioration after soldering, please assure the coating material is not adhered on any part of connector.
- Please avoid the usage of connector as electric switching basically.
- Please care to the FPC pattern design such as the width and thickness, because the FPC has risk for excessive temperature rise due to factors on the FPC side.

Please refer to **"the latest product specifications"** when designing your product.

•Requests to customers:

<https://industrial.panasonic.com/ac/e/salespolicies/>





**Panasonic Industry Co., Ltd.**

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